Presettable synchronous 4-bit binary up/down counter

Rev. 4 — 24 June 2013

Product data sheet

1. General description

The 74HC193; 74HCT193 is a 4-bit synchronous binary up/down counter. Separate up/down clocks, CPU and CPD respectively, simplify operation. The outputs change state synchronously with the LOW-to-HIGH transition of either clock input. If the CPU clock is pulsed while CPD is held HIGH, the device will count up. If the CPD clock is pulsed while CPU is held HIGH, the device will count down. Only one clock input can be held HIGH at any time to guarantee predictable behaviour. The device can be cleared at any time by the asynchronous master reset input (MR); it may also be loaded in parallel by activating the asynchronous parallel load input (PL). The terminal count up (TCU) and terminal count down (TCD) outputs are normally HIGH. When the circuit has reached the maximum count state of 15, the next HIGH-to-LOW transition of CPU will cause TCU to go LOW. TCU will stay LOW until CPU goes HIGH again, duplicating the count up clock. Likewise, the TCD output will go LOW when the circuit is in the zero state and the CPD goes LOW. The terminal count outputs can be used as the clock input signals to the next higher order circuit in a multistage counter, since they duplicate the clock waveforms. Multistage counters will not be fully synchronous, since there is a slight delay time difference added for each stage that is added. The counter may be preset by the asynchronous parallel load capability of the circuit. Information present on the parallel data inputs (D0 to D3) is loaded into the counter and appears on the outputs (Q0 to Q3) regardless of the conditions of the clock inputs when the parallel load (PL) input is LOW. A HIGH level on the master reset (MR) input will disable the parallel load gates, override both clock inputs and set all outputs (Q0 to Q3) LOW. If one of the clock inputs is LOW during and after a reset or load operation, the next LOW-to-HIGH transition of that clock will be interpreted as a legitimate signal and will be counted. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Input levels:
 - For 74HC193: CMOS level
 - For 74HCT193: TTL level
- Synchronous reversible 4-bit binary counting
- Asynchronous parallel load
- Asynchronous reset
- Expandable without external logic
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V.



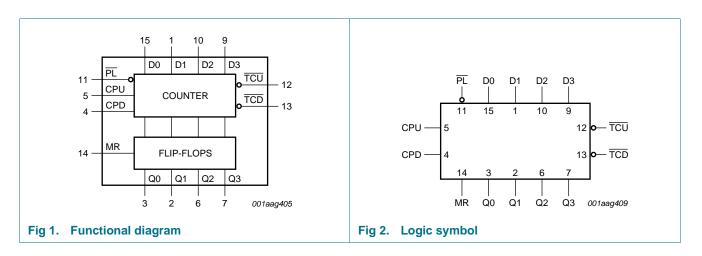
Presettable synchronous 4-bit binary up/down counter

- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

3. Ordering information

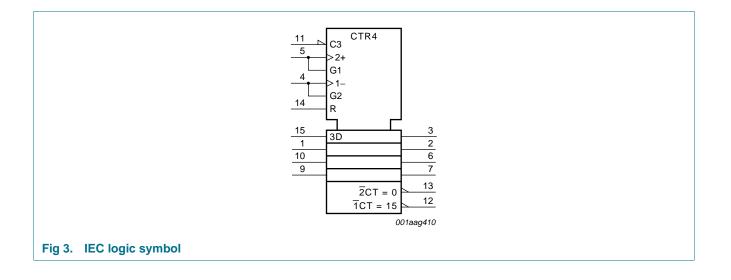
Table 1. Orde	ering information			
Type number	Package			
	Temperature range	Name	Description	Version
74HC193D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HC193DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74HC193N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
74HC193PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74HCT193D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT193DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74HCT193N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
74HCT193PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

4. Functional diagram



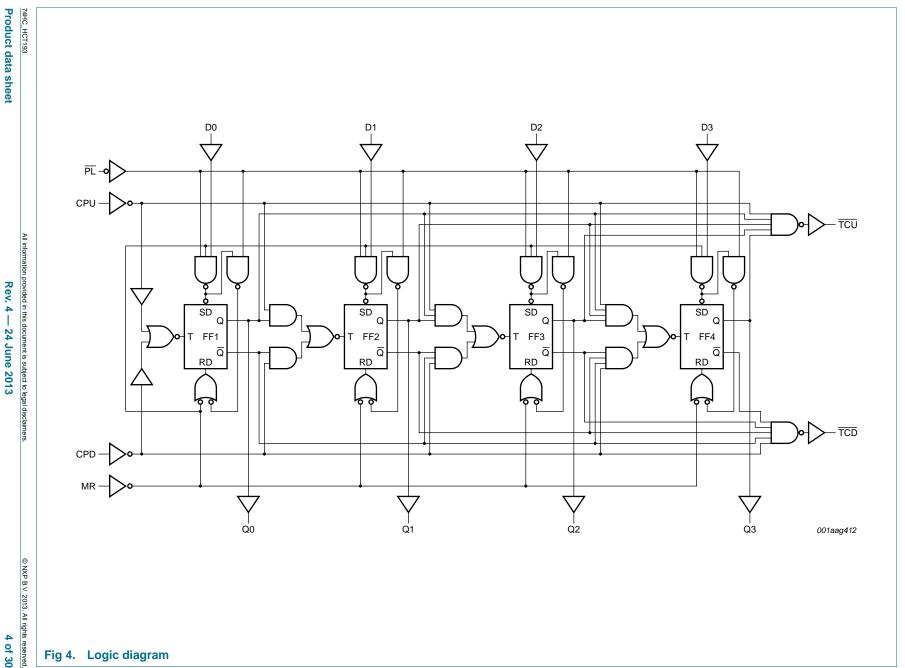
74HC193; 74HCT193

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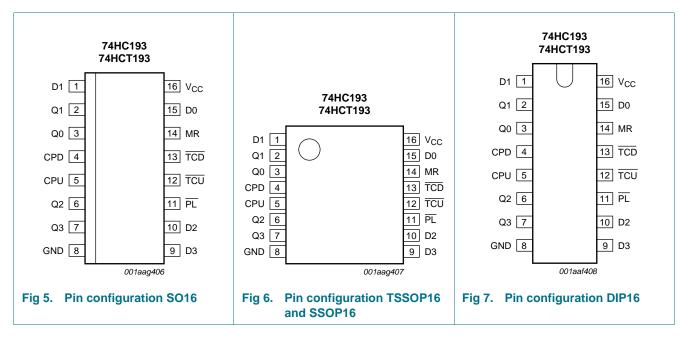
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
D0	15	data input 0
D1	1	data input 1
D2	10	data input 2
D3	9	data input 3
Q0	3	flip-flop output 0
Q1	2	flip-flop output 1
Q2	6	flip-flop output 2
Q3	7	flip-flop output 3
CPD	4	count down clock input ^[1]
CPU	5	count up clock input ^[1]
GND	8	ground (0 V)
PL	11	asynchronous parallel load input (active LOW)
TCU	12	terminal count up (carry) output (active LOW)
TCD	13	terminal count down (borrow) output (active LOW)
MR	14	asynchronous master reset input (active HIGH)
V _{CC}	16	supply voltage

[1] LOW-to-HIGH, edge triggered.

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6. Functional description

Table 3. Function table^[1]

Operating mode	Inputs							Outp	Outputs					
	MR	PL	CPU	CPD	D0	D1	D2	D3	Q0	Q1	Q2	Q3	TCU	TCD
Reset (clear)	Н	Х	Х	L	Х	Х	Х	Х	L	L	L	L	Н	L
	Н	Х	Х	Н	Х	Х	Х	Х	L	L	L	L	Н	Н
Parallel load	L	L	Х	L	L	L	L	L	L	L	L	L	Н	L
	L	L	Х	Н	L	L	L	L	L	L	L	L	Н	Н
	L	L	L	Х	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
	L	L	Н	Х	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
Count up	L	Н	↑	Н	Х	Х	Х	Х	count up		H <mark>[2]</mark>	Н		
Count down	L	Н	Н	↑	Х	Х	Х	Х	coun	count down		Н	H <mark>[3]</mark>	

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

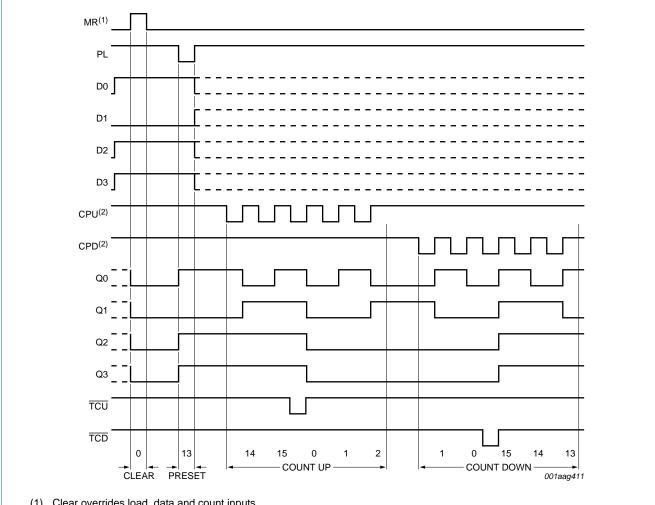
 \uparrow = LOW-to-HIGH clock transition.

[2] $\overline{\text{TCU}} = \text{CPU}$ at terminal count up (HHHH)

[3] $\overline{\text{TCD}} = \text{CPD}$ at terminal count down (LLLL).

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- (1) Clear overrides load, data and count inputs.
- When counting up, the count down clock input (CPD) must be HIGH, when counting down the count up clock input (2) (CPU) must be HIGH.

Sequence

Clear (reset outputs to zero);

load (preset) to binary thirteen;

count up to fourteen, fifteen, terminal count up, zero, one and two;

count down to one, zero, terminal count down, fifteen, fourteen and thirteen.

Fig 8. Typical clear, load and count sequence

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Max	Unit
supply voltage		-0.5	+7.0	V
input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
output current	$V_{\rm O}$ = –0.5 V to V_{CC} + 0.5 V	-	±25	mA
supply current		-	50	mA
ground current		-	-50	mA
storage temperature		-65	+150	°C
total power dissipation	DIP16 package	[2] _	750	mW
	SO16 package	[2] _	500	mW
	SSOP16 package	[2] _	500	mW
	TSSOP16 package	[2] _	500	mW
	supply voltage input clamping current output clamping current output current supply current ground current storage temperature	$\begin{tabular}{ c c c } & $supply voltage & $V_1 < -0.5 V \ or \ V_1 > V_{CC} + 0.5 V \\ $output clamping current & $V_0 < -0.5 V \ or \ V_0 > V_{CC} + 0.5 V \\ $output current & $V_0 = -0.5 V \ to \ V_{CC} + 0.5 V \\ $supply current & $V_0 = -0.5 V \ to$	supply voltage-0.5input clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{CC} + 0.5 V$ [1] -output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{CC} + 0.5 V$ [1] -output current $V_0 = -0.5 V \text{ to } V_{CC} + 0.5 V$ -supply currentground currentstorage temperature-65total power dissipationDIP16 package[2] -SO016 package[2] -SOP16 package[2] -	supply voltage -0.5 +7.0 input clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{CC} + 0.5 V$ 11 - ±20 output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{CC} + 0.5 V$ 11 - ±20 output current $V_0 = -0.5 V \text{ to } V_{CC} + 0.5 V$ 11 - ±20 output current $V_0 = -0.5 V \text{ to } V_{CC} + 0.5 V$ - ±25 supply current - - 50 ground current - - -50 storage temperature -65 +150 total power dissipation DIP16 package [2] - 750 SO016 package [2] - 500

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For DIP16 packages: above 70 °C the value of P_{tot} derates linearly at 12 mW/K.
 For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.
 For SSOP16 and TSSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

		-				
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
74HC193	3					
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	ns/V
74HCT19	93					
V _{CC}	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 4.5 V$	-	1.67	139	ns/V

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9. Static characteristics

Table 6. Static characteristics type 74HC193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		$V_{CC} = 4.5 V$	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	V
V _{он}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$	-	-	-	
		$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	V
		I_O = -4.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	V
		$I_0 = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	-	0	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	μA
lcc	supply current	$V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}; V_{CC} = 6.0 \text{ V}$	-	-	8.0	μA
C _i	input capacitance		-	3.5	-	pF
T _{amb} = -4	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.8	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	-	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	-	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	-	-	V
		$I_0 = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	-	_	V

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Parameter	Conditions	Min	Тур	Max	Unit
LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
	$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	-	-	0.1	V
	$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	-	0.1	V
	I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	-	0.33	V
	$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.33	V
input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±1.0	μA
supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	80	μA
) °C to +125 °C					
HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
	$V_{CC} = 4.5 V$	3.15	-	-	V
	$V_{CC} = 6.0 V$	4.2	-	-	V
LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
	$V_{CC} = 4.5 V$	-	-	1.35	V
	$V_{CC} = 6.0 V$	-	-	1.8	V
HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
	I_O = –20 $\mu A;V_{CC}$ = 2.0 V	1.9	-	-	V
	$I_O = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	-	-	V
	$I_O = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	-	-	V
	I_{O} = -4.0 mA; V_{CC} = 4.5 V	3.7	-	-	V
	I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.2	-	-	V
LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
	$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
	$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	-	0.1	V
	I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	-	0.4	V
	$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.4	V
input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μA
supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	160	μA
	LOW-level output voltage input leakage current supply current O °C to +125 °C HIGH-level input voltage LOW-level input voltage HIGH-level output voltage LOW-level output voltage	$ \begin{tabular}{lllllllllllllllllllllllllllllllllll$	$ \begin{tabular}{ c $	$ \begin{tabular}{ c $	$ \begin{tabular}{ c $

Table 6. Static characteristics type 74HC193 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Table 7. Static characteristics type 74HCT193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

			-			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I _O = -20 μA	4.4	4.5	-	V
		$I_{O} = -4.0 \text{ mA}$	3.98	4.32	-	V

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I _O = 20 μA	-	0	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	V
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	μΑ
Δl _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1$ V and other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	35	126	μA
		pins CPU, CPD	-	140	504	μA
		pin PL	-	65	234	μA
		pin MR	-	105	378	μA
C _i	input capacitance		-	3.5	-	pF
T _{amb} = -4	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V _{OH} HIGH-level output voltage		$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I _O = -20 μA	4.4	-	-	V
		$I_{O} = -4.0 \text{ mA}$	3.84	-	-	V
V _{OL} L	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I _O = 20 μA	-	-	0.1	V
		I _O = 4.0 mA	-	-	0.33	V
l _l	input leakage current	$V_{I} = V_{CC} \text{ or GND}; V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	80	μA
Δl _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1$ V and other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	-	157.5	μA
		pins CPU, CPD	-	-	630	μA
		pin PL	-	-	292.5	μA
		pin MR	-	-	472.5	μA
T _{amb} = -4	0 °C to +125 °C					
VIH	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V _{OH}	HIGH-level output voltage	V_{I} = V_{IH} or $V_{IL};V_{CC}$ = 4.5 V				
		I _O = -20 μA	4.4	-	-	V
		$I_{O} = -4.0 \text{ mA}$	3.7	-	-	V
V _{OL}	LOW-level output voltage	V_{I} = V_{IH} or $V_{IL};V_{CC}$ = 4.5 V				
		I _O = 20 μA	-	-	0.1	V
		I _O = 4.0 mA	-	-	0.4	V
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Static characteristics type 74HCT193 ... continued Table 7.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	160	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1$ V and other inputs at V_{CC} or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V				
		pin Dn	-	-	171.5	μΑ
		pins CPU, CPD	-	-	686	μΑ
		pin PL	-	-	318.5	μA
		pin MR	-	-	514.5	μA

Table 7. Static characteristics type 74HCT193 ...continued

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10. Dynamic characteristics

Table 8.	Dynamic char	acteristics type 74HC1	193								
Symbol	Parameter	Conditions			25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation delay	CPU, CPD to Qn; see <u>Figure 9</u>	<u>[1]</u>	-							
		$V_{CC} = 2.0 V$		-	63	215	-	270	-	325	ns
		$V_{CC} = 4.5 V$		-	23	43	-	54	-	65	ns
		$V_{CC} = 6.0 V$		-	18	37	-	46	-	55	ns
		CPU to TCU; see Figure 10									
		$V_{CC} = 2.0 V$		-	39	125	-	155	-	190	ns
		$V_{CC} = 4.5 V$		-	14	25	-	31	-	38	ns
		$V_{CC} = 6.0 V$		-	11	21	-	26	-	32	ns
		CPD to TCD; see Figure 10									
		$V_{CC} = 2.0 V$		-	39	125	-	155	-	190	ns
		$V_{CC} = 4.5 V$		-	14	25	-	31	-	38	ns
		$V_{CC} = 6.0 V$		-	11	21	-	26	-	32	ns
	PL to Qn; see Figure 11										
		$V_{CC} = 2.0 V$		-	69	220	-	275	-	330	ns
		$V_{CC} = 4.5 V$		-	25	44	-	55	-	66	ns
		$V_{CC} = 6.0 V$		-	20	37	-	47	-	56	ns
		MR to Qn; see Figure 12									
		$V_{CC} = 2.0 V$		-	58	200	-	250	-	300	ns
		$V_{CC} = 4.5 V$		-	21	40	-	50	-	60	ns
		$V_{CC} = 6.0 V$		-	17	34		43	-	51	ns
		Dn to Qn; see Figure 11									
		$V_{CC} = 2.0 V$		-	69	210	-	265	-	315	ns
		$V_{CC} = 4.5 V$		-	25	42	-	53	-	63	ns
		$V_{CC} = 6.0 V$		-	20	36	-	45	-	54	ns
		PL to TCU, PL to TCD; see Figure 14									
		$V_{CC} = 2.0 V$		-	80	290	-	365	-	435	ns
		$V_{CC} = 4.5 V$		-	29	58	-	73	-	87	ns
		$V_{CC} = 6.0 V$		-	23	49	-	62	-	74	ns
		MR to TCU, MR to TCD; see Figure 14									
		$V_{CC} = 2.0 V$		-	74	285	-	355	-	430	ns
		$V_{CC} = 4.5 V$		-	27	57	-	71	-	86	ns
		$V_{CC} = 6.0 V$		-	22	48	-	60	-	73	ns

ble 8 Dynamic characteristics type 74HC1

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Table 8.	Dynamic charac	cteristics type 74HC193	continu	ued						
Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Uni
			Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation delay	<u>Dn to</u> TCU, Dn to TCD; see <u>Figure 14</u>								
		$V_{CC} = 2.0 V$	-	80	290	-	365	-	435	ns
		$V_{CC} = 4.5 V$	-	29	58	-	73	-	87	ns
		$V_{CC} = 6.0 V$	-	23	49	-	62	-	74	ns
THL	HIGH to LOW	see Figure 12								
	output transition time	$V_{CC} = 2.0 V$	-	19	75	-	95	-	110	ns
	ume	$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$	-	6	13	-	16	-	19	ns
TLH	LOW to HIGH	see Figure 12								
	output transition time	$V_{CC} = 2.0 V$	-	19	75	-	95	-	110	ns
	ume	$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$	-	6	13	-	16	-	19	ns
t _W	pulse width	CPU, CPD (HIGH or LOW); see <u>Figure 9</u>								
		$V_{CC} = 2.0 V$	100	22	-	125	-	150	-	ns
		$V_{CC} = 4.5 V$	20	8	-	25	-	30	-	ns
		$V_{CC} = 6.0 V$	17	6	-	21	-	26	-	ns
		MR (HIGH); see Figure 12								
		$V_{CC} = 2.0 V$	100	25	-	125	-	150	-	ns
		$V_{CC} = 4.5 V$	20	9	-	25	-	30	-	ns
		$V_{CC} = 6.0 V$	17	7	-	21	-	26	-	ns
		PL (LOW); see Figure 11								
		$V_{CC} = 2.0 V$	100	19	-	125	-	150	-	ns
		$V_{CC} = 4.5 V$	20	7	-	25	-	30	-	ns
		$V_{CC} = 6.0 V$	17	6	-	21	-	26	-	ns
rec	recovery time	PL to CPU, CPD; see <u>Figure 11</u>								
		$V_{CC} = 2.0 V$	50	8	-	65	-	75	-	ns
		$V_{CC} = 4.5 V$	10	3	-	13	-	15	-	ns
		$V_{CC} = 6.0 V$	9	2	-	11	-	13	-	ns
		MR to CPU, CPD; see Figure 12								
		$V_{CC} = 2.0 V$	50	0	-	65	-	75	-	ns
		$V_{CC} = 4.5 V$	10	0	-	13	-	15	-	ns
		$V_{CC} = 6.0 V$	9	0	-	11	-	13	-	ns

Table 8. Dynamic characteristics type 74HC193 ...continued

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Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{su}	set-up time	Dn to PL; see Figure 13; note: CPU = CPD = HIGH			'	'				
		$V_{CC} = 2.0 V$	80	22	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$	16	8	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$	14	6	-	17	-	20	-	ns
t _h I	hold time	Dn to PL; see Figure 13								
		$V_{CC} = 2.0 V$	0	-14	-	0	-	0	-	ns
		$V_{CC} = 4.5 V$	0	-5	-	0	-	0	-	ns
		$V_{CC} = 6.0 V$	0	-4	-	0		0	-	ns
		CPU to CPD, CPD to CPU; see Figure 15								
		$V_{CC} = 2.0 V$	80	22	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$	16	8	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$	8	6	-	17	-	20	-	ns
f _{max}	maximum frequency	CPU, CPD; see Figure 9								
		$V_{CC} = 2.0 V$	4.0	13.5	-	3.2	-	2.6	-	MHz
		$V_{CC} = 4.5 V$	20	41	-	16	-	13	-	MHz
		$V_{CC} = 6.0 V$	24	49	-	19	-	15	-	MHz
C _{PD}	power dissipation capacitance	$V_{I} = GND \text{ to } V_{CC};$ $V_{CC} = 5 \text{ V};$ $f_{i} = 1 \text{ MHz}$	[2] _	24	-	-	-	-	-	pF

Table 8. Dynamic characteristics type 74HC193 ...continued

 $\label{eq:tpd} [1] \quad t_{pd} \text{ is the same as } t_{PHL} \text{ and } t_{PLH}.$

 $[2] \quad C_{PD} \text{ is used to determine the dynamic power dissipation (P_D in <math>\mu$ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$

 $f_i = input frequency in MHz;$

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

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Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
- ,			Min	Тур	Max	Min	Max	Min	Max	-
t _{pd}	propagation delay	CPU, CPD to Qn; [1] see <u>Figure 9</u>		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,						
		$V_{CC} = 4.5 V$	-	23	43	-	54	-	65	ns
		CPU to TCU; see Figure 10								
		$V_{CC} = 4.5 V$	-	15	27	-	34	-	41	ns
		CPD to TCD; see Figure 10								
		$V_{CC} = 4.5 V$	-	15	27	-	34	-	41	ns
		PL to Qn; see Figure 11								
		$V_{CC} = 4.5 V$	-	26	46	-	58	-	69	ns
		MR to Qn; see Figure 12								
		$V_{CC} = 4.5 V$	-	22	40	-	50	-	60	ns
		Dn to Qn; see Figure 11								
		$V_{CC} = 4.5 V$	-	27	46	-	58	-	69	ns
		PL to TCU, PL to TCD; see <u>Figure 14</u>								
		$V_{CC} = 4.5 V$	-	31	55	-	69	-	83	ns
		MR to TCU, MR to TCD; see Figure 14								
		$V_{CC} = 4.5 V$	-	29	55	-	69	-	83	ns
		Dn to TCU, Dn to TCD; see <u>Figure 14</u>								
		$V_{CC} = 4.5 V$	-	32	58	-	73	-	87	ns
t _{THL} HIGH to LOW		see Figure 12								
	output transition time	$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
t _{TLH}	LOW to HIGH	see Figure 12								
	output transition time	$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
t _W	pulse width	CPU, CPD (HIGH or LOW); see <u>Figure 9</u>								
		V _{CC} = 4.5 V	25	11	-	31	-	38	-	ns
		MR (HIGH); see Figure 12								
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		PL (LOW); see Figure 11								
		V _{CC} = 4.5 V	20	8	-	25	-	30	-	ns

Table 9. Dynamic characteristics type 74HCT193

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Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{rec}	recovery time	PL to CPU, CPD; see <u>Figure 11</u>	1	1	1			'		
		$V_{CC} = 4.5 V$	10	2	-	13	-	15	-	ns
		MR to CPU, CPD; see Figure 12								
		$V_{CC} = 4.5 V$	10	0	-	13	-	15	-	ns
t _{su} set-up time	set-up time	Dn to <u>PL;</u> see <u>Figure 13</u> ; note: CPU = CPD = HIGH								
		$V_{CC} = 4.5 V$	16	8	-	20	-	24	-	ns
t _h	hold time	Dn to PL; see Figure 13								
		$V_{CC} = 4.5 V$	0	-6	-	0	-	0	-	ns
		CPU to CPD, CPD to CPU; see Figure 15								
		$V_{CC} = 4.5 V$	16	7	-	20	-	24	-	ns
f _{max}	maximum frequency	CPU, CPD; see Figure 9								
		$V_{CC} = 4.5 V$	20	43	-	16	-	13	-	MHz
C _{PD}	power dissipation capacitance	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ to } V_{CC} - \\ 1.5 \text{ V}; V_{CC} = 5 \text{ V}; \\ f_{i} = 1 \text{ MHz} \end{array}$	[2] _	26	-	-	-	-	-	pF

Table 9. Dynamic characteristics type 74HCT193 ...continued

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $\mathsf{P}_{\mathsf{D}} = C_{\mathsf{PD}} \times V_{\mathsf{CC}}{}^2 \times f_i \times \mathsf{N} + \Sigma (C_L \times V_{\mathsf{CC}}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

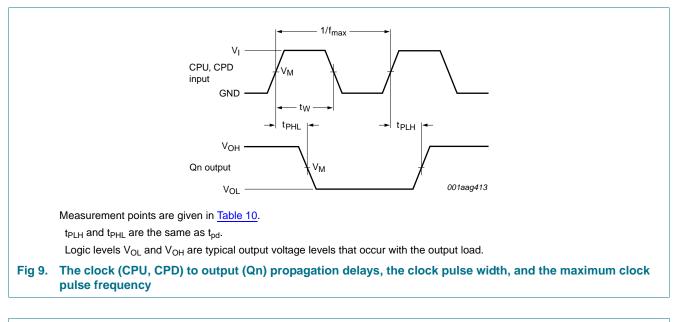
N = number of inputs switching;

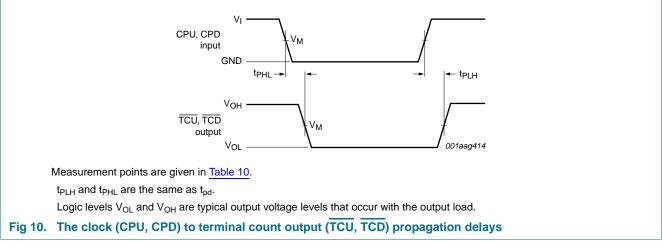
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

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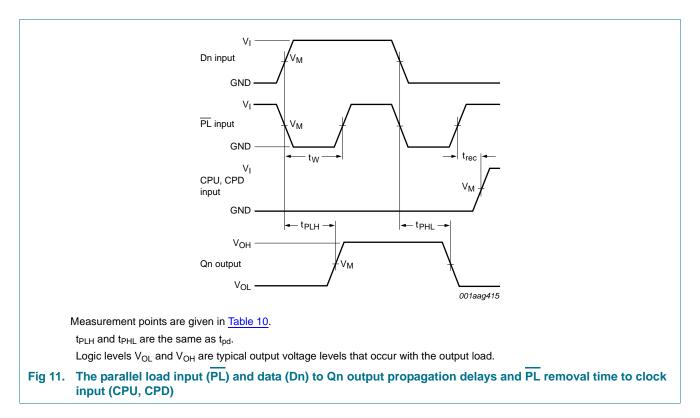
11. Waveforms

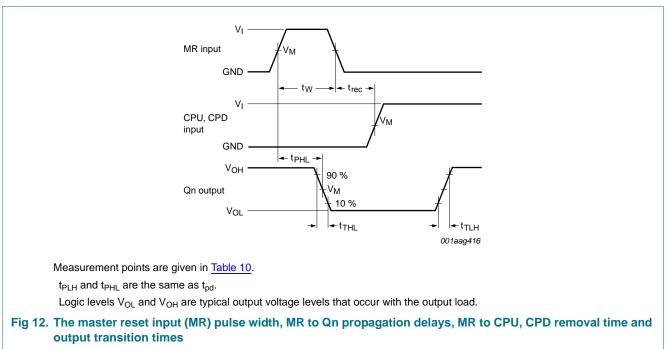




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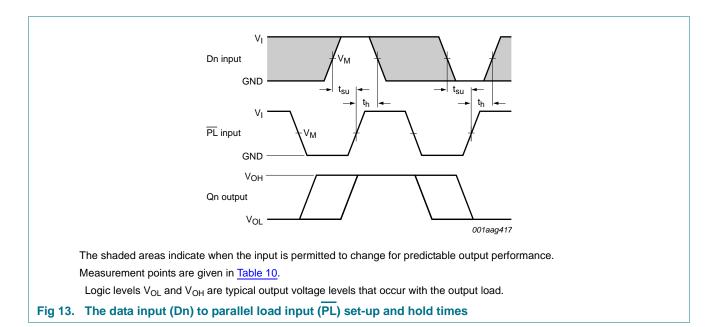
Presettable synchronous 4-bit binary up/down counter

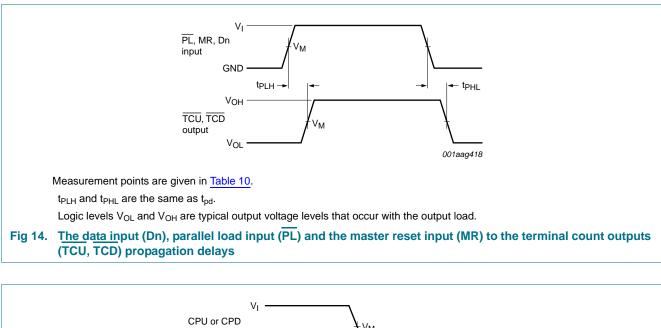


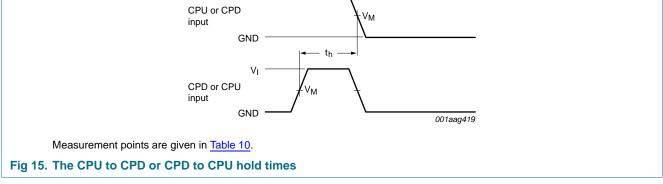


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Table 10.Measurement	points		
Туре	Input		Output
	V _M	VI	V _M
74HC193	$0.5\times V_{CC}$	GND to V _{CC}	$0.5\times V_{CC}$
74HCT193	1.3 V	GND to 3 V	1.3 V

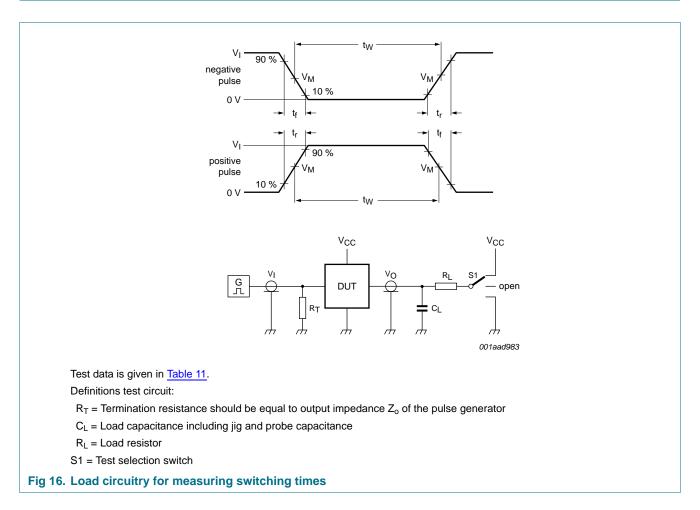
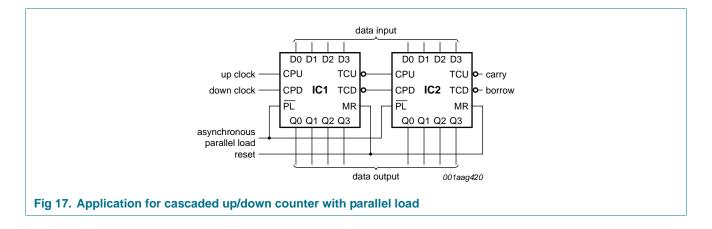


Table 11. Test data

Туре	Input		Load	S1 position	
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}
74HC193	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT193	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

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12. Application information



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13. Package outline

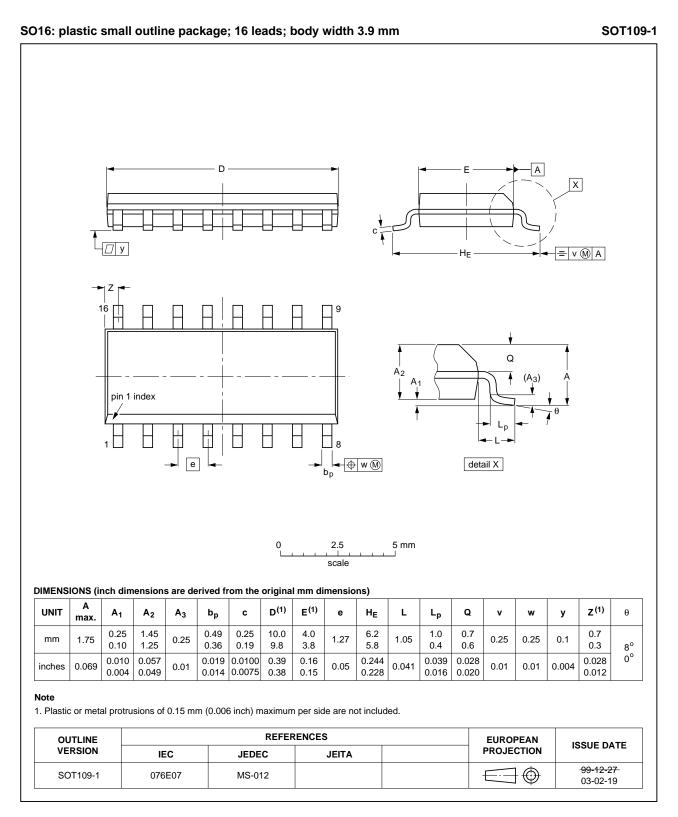


Fig 18. Package outline SOT109-1 (SO16)

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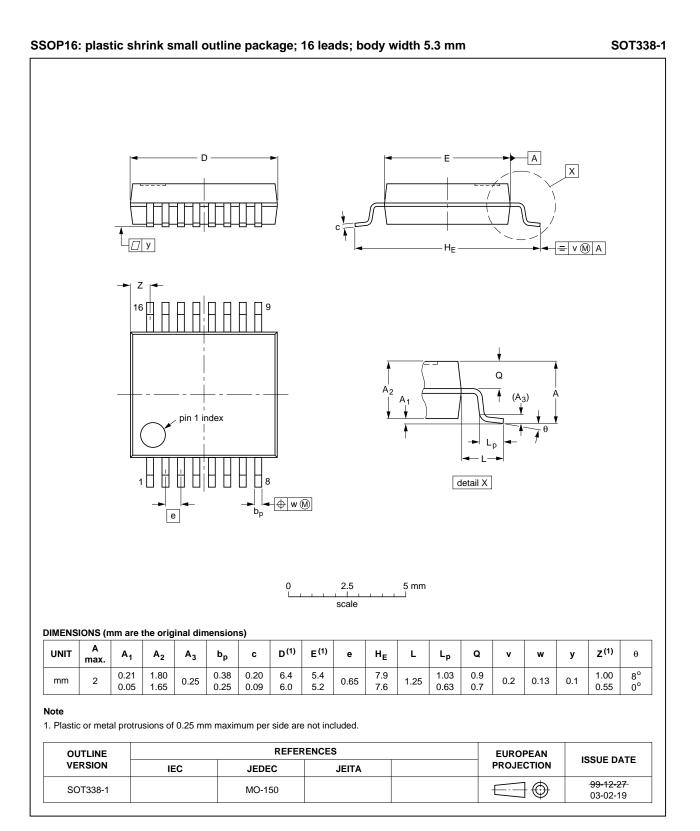


Fig 19. Package outline SOT338-1 (SSOP16)

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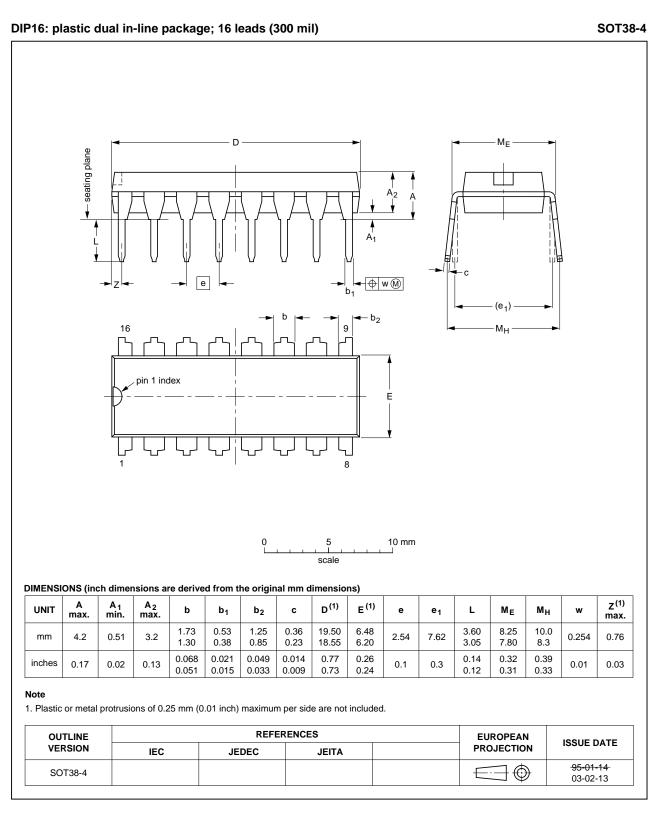


Fig 20. Package outline SOT38-4 (DIP16)

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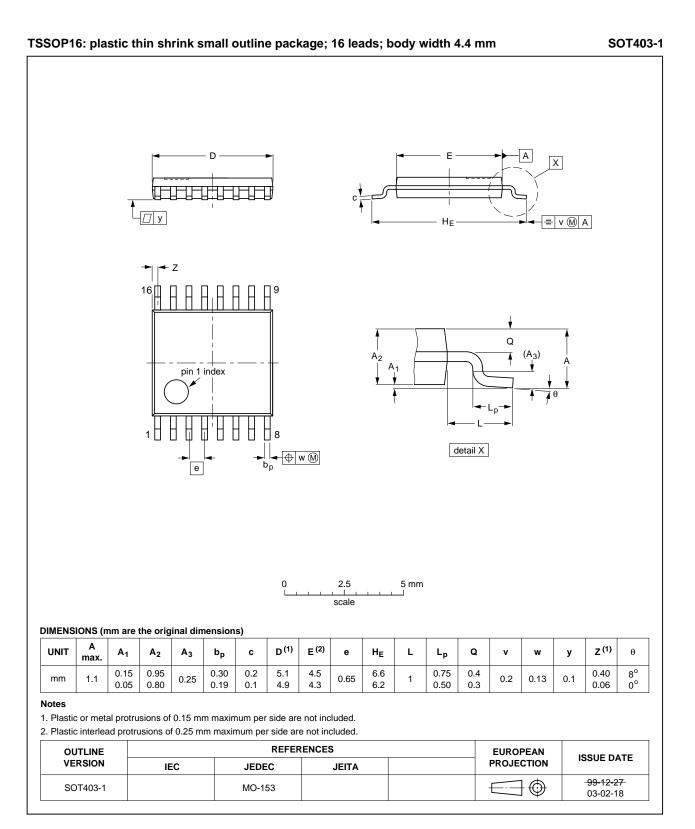


Fig 21. Package outline SOT403-1 (TSSOP16)

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14. Abbreviations

Table 12.	Abbreviations
Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
LSTTL	Low-power Schottky Transistor-Transistor Logic
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 13.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT193 v.4	20130624	Product data sheet	-	74HC_HCT193 v.3
Modifications:	 General des 	scription updated.		
74HC_HCT193 v.3	20070523	Product data sheet	-	74HC_HCT193_CNV v.2
Modifications:		of this data sheet has been f NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts I 	have been adapted to the r	new company name whe	ere appropriate.
	 Family spec 	ification included		
74HC_HCT193_CNV v.2	19970828	Product specification	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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